WS2812C-2020 Intelligent control LED integrated light source

Features and Benefits

- The control integrated circuit and the LED share the only power source.
- 5mA operating current per channel.
- Control circuit and RGB chip are integrated in a package of 2020 components, to form a complete addressable pixel.
- Built-in signal reshaping circuit, after wave reshaping to the next driver, ensure wave-form distortion not accumulate.
- Built-in electric reset circuit and power lost reset circuit.
- Each pixel of the three primary color can achieve 256 brightness display, completed 16777216 color full color display, and scan frequency is of **2KHz**.
- Cascading port transmission signal by single line.
- Any two point the distance not more than 3m transmission signal without any increase circuit.
- When the refresh rate is 30fps, cascade number are not less than 1024 pixels.
- Send data at speeds of 800Kbps.
- The color of the light is highly consistent, cost-effective..

Applications

- Full-color module, Full color soft lights a lamp strip.
- LED decorative lighting, Indoor/outdoor LED irregular screen, game machine and amusement equipment etc.

General description

WS2812C-2020 is an intelligent control LED light source, its exterior adopts the latest MOLDING packaging technology, the control circuit and RGB chips are integrated in a package of **2020** component. Its internal includes intelligent digital port data latch and signal reshaping amplification drive circuit. Also include a precision internal oscillator and a voltage programmable constant current control part, effectively ensuring the pixel point light color height consistent.

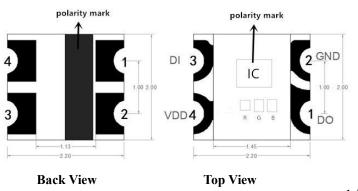
The data transfer protocol use single NZR communication mode. After the pixel power-on reset, the DIN port receive data from controller, the first pixel collect initial 24bit data then sent to the internal data latch, the other data which reshaping by the internal signal reshaping amplification circuit sent to the next cascade pixel through the DO port. After transmission for each pixel, the signal to reduce 24bit. pixel adopt auto reshaping transmit technology, making the pixel cascade number is not limited the signal transmission, only depend on the speed of signal transmission.

RESET time >280µs, it won't cause wrong reset while interruption, it supports the lower frequency and inexpensive MCU.

Refresh Frequency updates to 2KHz, Low Frame Frequency and No Flicker appear in HD Video Camera, it improve excellent display effect.

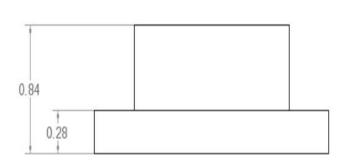
LED with low driving voltage, environmental protection and energy saving, high brightness, large scattering angle, good consistency, low power, long life and other advantages. The control chip integrated in LED above becoming more simple circuit, small volume, convenient installation.

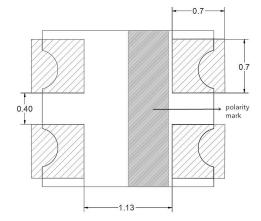
Mechanical Dimensions



https://www.superlightingled.com/

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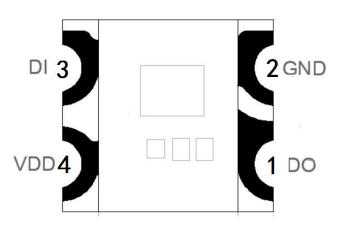




PCB Solder Pad

Side View

PIN Configuration



PIN Function

| NO. | Symbol | PIN | Function description | | | | |
|-----|--------|--------------|--------------------------------|--|--|--|--|
| 1 | DO | DATA OUT | Control data signal output | | | | |
| 2 | GND | GROUND | Ground, data & power grounding | | | | |
| 3 | DI | DATA IN | Control data signal input | | | | |
| 4 | VDD | POWER SUPPLY | Power supply | | | | |

Absolute Maximum Ratings

| Parameter | Symbol | Ratings | Unit |
|--------------------------------|-----------------|-----------------|------|
| Power supply voltage | V _{DD} | +3.7~+5.3 | V |
| Logical Input Voltage | VI | VDD-0.7~VDD+0.7 | V |
| Operation junction temperature | Topt | -25~+85 | °C |
| Storage temperature range | Tstg | -40~+105 | °C |

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| Electrical Characteristics (T_A =-20~+70°C, V_{DD} =4.5~5.5V, V_{SS} =0V, unless otherwise specified) | | | | | | | | | | |
|--------------------------------------------------------------------------------------------------------------|------------------|--------------|------|---------------------|------|--------------------------------------------------|--|--|--|--|
| Parameter | Symbol | Min | Тру | Max | Unit | Conditions | | | | |
| Input current | II | | | ±1 | μΑ | V _I =V _{DD} /V _{SS} | | | | |
| Innut voltage level | V _{IH} | $0.7 V_{DD}$ | | | V | D _{IN} , SET | | | | |
| Input voltage level | V _{IL} | | | 0.3 V _{DD} | V | D _{IN} , SET | | | | |
| Hysteresis voltage | V_{H} | | 0.35 | | V | D _{IN} , SET | | | | |

Switching Characteristics (T_A =-20~+70°C, V_{DD} =4.5~5.5V, V_{SS} =0V, unless otherwise specified)

| Parameter | Symbol | Min | Тру | Max | Unit | Condition |
|-------------------------|-----------|-----|-----|-----|------|--------------------------------------------------|
| Transmission delay time | t_{PLZ} | | | 300 | ns | CL=15pF, DIN \rightarrow DOUT, RL=10K Ω |
| Fall time | tTHZ | | | 120 | μs | CL=300pF, OUTR/OUTG/OUTB |
| Input capacity | CI | | | 15 | pF | |

LED Characteristics

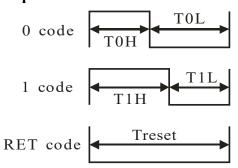
| Parameter | Symbol | Color | | Quiescent | Test Condition | | | |
|--------------------|--------|-------|------|-----------|----------------|------|-------------------|--|
| | | | Min. | Тур. | Max. | Unit | (Working current) | |
| | | RED | 33 | | 40 | | | |
| Luminous intensity | IV | GREEN | 120 | | 144 | mcd | 5mA | |
| | | BLUE | 28 | | 34 | | | |
| | | RED | 620 | | 625 | | | |
| Wavelength | λd | GREEN | 520 | | 525 | nm | 5mA | |
| | | BLUE | 460 | | 465 | | | |

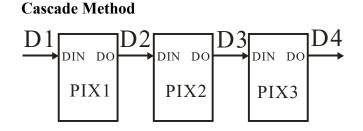
Data Transfer Time

| ТОН | 0 code, high voltage time | 220ns~380ns |
|-----|------------------------------|-------------|
| T1H | 1 code, high voltage time | 580ns~1µs |
| TOL | 0 code, low voltage time | 580ns~1µs |
| T1L | 1 code, low voltage time | 220ns~420ns |
| RES | Frame unit, low voltage time | >280µs |

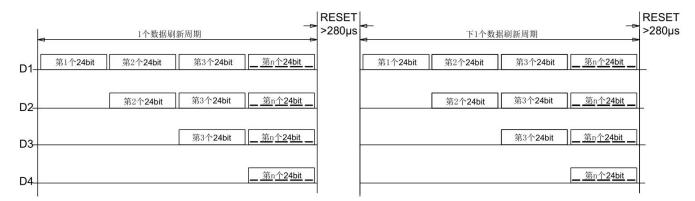
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Sequence Chart





Data Transmission Method



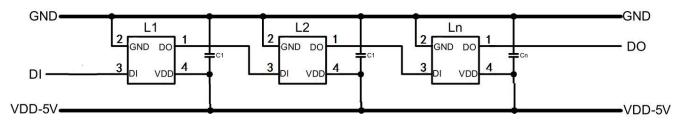
Note: The data of D1 is send by MCU, and D2, D3, D4 through pixel internal reshaping amplification to transmit.

Composition of 24bit Data

| G7 | G6 | G5 | G4 | G3 | G2 | G1 | G0 | R7 | R6 | R5 | R4 | R3 | R2 | R1 | R0 | B7 | B6 | В5 | B4 | B3 | B2 | B1 | B0 |
|----|------------------------------------------------------------|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| No | Note: Data transmit in order of GRB high bit data at first | | | | | | | | | | | | | | | | | | | | | | |

transmit in order of GRB, high bit data at first.

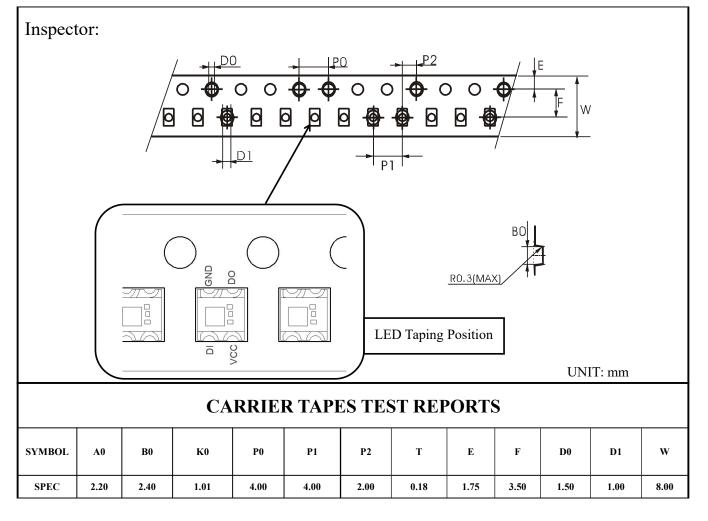
Typical Application Circuit



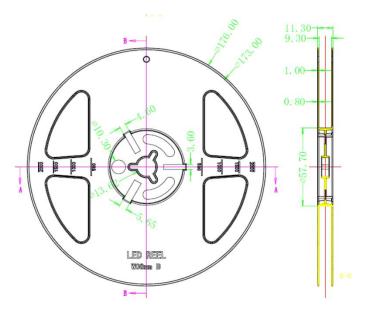
Remarks: C1 is the filter capacitor for VDD, its value of 100nF.

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Tape Size (Unit: mm)



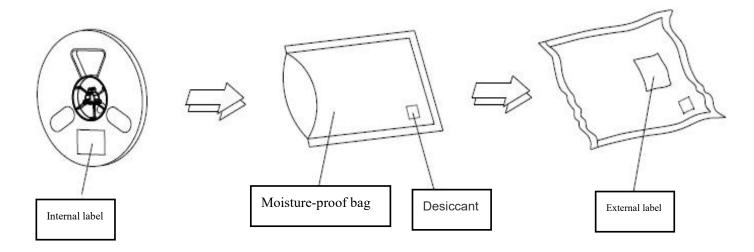
Reel Packing Specifications (Unit: mm)



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Moistureproof bag packing

SPQ: 4000PCS /Reel



Top SMD LED Using Instructions

1. Summary

To make the best use of WORLDSEMI's LED, please refer to the below precautions, they are of same usage method as other electronic components.

2. Cautions

2.1. Dust & Cleaning

The surface of the LED is encapsulated with modified epoxy resin because it plays a very good role in protecting the optical performance and aging resistance. The modified epoxy resin is easy to stick with dust and must be kept clean. When there's a certain amount of dust on the surface of the LED, it won't affect brightness, but dust proof should be taken care of. Promoting the use of unsealed package in preference to others and the assembled LEDs should be placed in a clean container.

Avoid using the organic solvents to clean the dust on the LED surface and it's necessary to confirm whether the cleaning fluid will dissolve the LED.

Do not clean the LEDs by the ultrasonic. Some parameters affecting the LED performance must be evaluated if have no alternative but to the ultrasonic cleaning method, such as ultrasonic power, baking time and assembly conditions, etc.

2.2. Moisture-proof packaging

TOP SMD LEDs are moisture sensitive components. LEDs are packaged in aluminum foil bag to prevent the from absorbing moisture during transport and storage. A desiccant is placed in the bags to absorb moisture. If the LED absorbs moisture, then it evaporates and expands when in reflow process, which may break the colloid from the bracket and damage the optical performance of LED. For this reason, moisture-proof packaging is to prevent the from absorbing moisture during transport and storage. The moisture resistance rating of WORLDSEMI's LED is: **LEVEL 6**.

| MSL Level | Workshop Life | | | | | | |
|-----------|------------------------------|-------------|--|--|--|--|--|
| | Time | Conditions | | | | | |
| LEVEL1 | Unlimited | ≤30°C/85%RH | | | | | |
| LEVEL2 | 1 Year | ≤30°C/60%RH | | | | | |
| LEVEL2a | 4 Weeks | ≤30°C/60%RH | | | | | |
| LEVEL3 | 168 Hours | ≤30°C/60%RH | | | | | |
| LEVEL4 | 72 Hours | ≤30°C160%RH | | | | | |
| LEVEL5 | 48 Hours | ≤30°C/60%RH | | | | | |
| LEVEL5a | 24 Hours | ≤30°C/60%RH | | | | | |
| LEVEL6 | Take-out and Use immediately | ≤30°C/60%RH | | | | | |

Tabel I - IPC/JEDEC J-STD-020 Moisture/Reflow Sensitivity Classification

2.3. Management after unpacking

It's recommend to perform SMT assembly as soon as possible after opening the moisture-proof bag, and reflow soldering should be completed within 4 hours after SMT assembly; for the remaining LEDs, they should be re-packed in seal package and placed in moisture-proof cabinet (Please note that it's necessary to rebake at "70°C-75°C/48 hours" before next SMT process).

3. Dehumidification Operation (Non-leakage of air, baking temperature:70°C-75°C)

- a. MD within 2 weeks, baking time: 24 hours.
- b. MD exceeds 2 weeks, baking time: 48 hours.

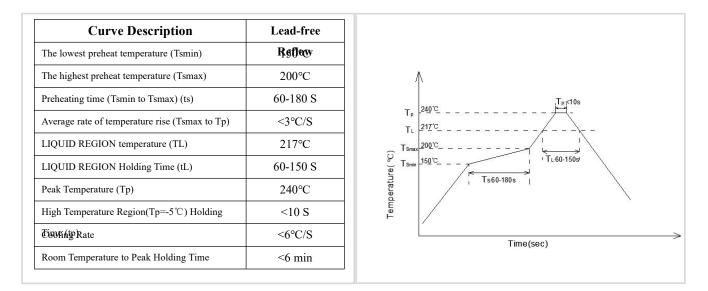
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4. Management of secondary SMT process

It's necessary to do moisture-proof treatment when the secondary reflow carried out that followed the first reflow. It can't be more than 2 hours to be exposed at condition of " $<30^{\circ}C/60^{\circ}RH$ " and dehumification operation is requested for a longer interval reflow. For instance, place in a drying box or a container with desiccant, and dehumidify it before the secondary reflow(Low temperature baking operation: $70^{\circ}C-75^{\circ}C$, ≥ 12 hours).

5. SMT Reflow

Refer to the parameters listed below, the experimental results prove that the TOP SMD LED meets the JEDEC J-STD-020C standards. As a general guideline, it is recommended to follow the SMT reflow temperature curve recommended by the solder paste manufacturer.



Remarks: 1. These general guidelines may not apply to all PCB designs and reflow soldering configurations.

2. All temperatures referred are measured on the surface of the package body.

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6. Assembly Precautions

| 1. Clip the LED from its side. | 2. Neither directly touch the gel surface with the hand |
|------------------------------------------------|-----------------------------------------------------------|
| | or sharp instrument, it may damage its internal circuit. |
| | |
| 3. Not to be double stacked, it may damage its | 4. Can not be stored in or applied in the acidic sites of |
| internal circuit. | PH<7. |
| | KPH7 |

Modify Record

| Version № | Status Bar | Modify Content Summary | Date | Reviser | Approved |
|-----------|------------|------------------------|----------|-------------|-------------|
| V1.0 | N | New-Official release | 20180701 | Shen JinGuo | Yin HuaPing |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |

Remarks: Initial version: V1.0; Version number plus "0.1" after each revision;

Status bar: N--New, A--Add, M--Modify, D--Delete.